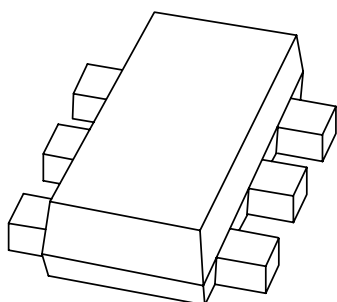


# DATA SHEET



## **PEMF21** 12 V PNP loadswitch

Product data sheet

2004 Jan 12

## 12 V PNP loadswitch

## PEMF21

## FEATURES

- Low  $V_{CEsat}$  transistor and resistor-equipped transistor in one package
- Very small  $1.6 \times 1.2$  mm ultra thin package
- Reduced component count.

## APPLICATIONS

- Line switches
- Battery charger switches
- Power supply switches
- Drive switches
- General purpose analog switches.

## DESCRIPTION

Low  $V_{CEsat}$  PNP transistor and NPN resistor-equipped transistor in a SOT666 plastic package (see "Ordering information" for package details).

## MARKING

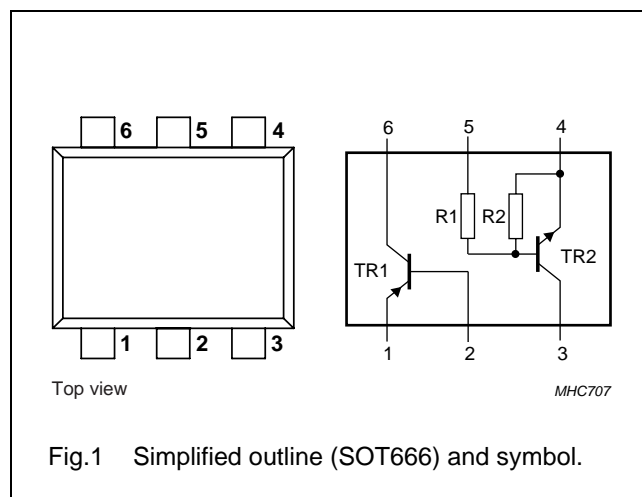
TYPE NUMBER	MARKING CODE
PEMF21	2F

## QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
<b>TR1; PNP; low <math>V_{CEsat}</math> transistor</b>				
$V_{CEO}$	collector-emitter voltage	–	–12	V
$I_C$	collector current (DC)	–	–500	mA
$R_{CEsat}$	equivalent on-resistance	–	500	m $\Omega$
<b>TR2; NPN; resistor-equipped transistor</b>				
$V_{CEO}$	collector-emitter voltage	–	50	V
$I_O$	output current (DC)	–	100	mA
R1	bias resistor	10	–	k $\Omega$
R2	bias resistor	10	–	k $\Omega$

## PINNING

PIN	DESCRIPTION
1	emitter TR1
2	base TR1
3	collector TR2
4	emitter TR2
5	base TR2
6	collector TR1



## ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
PEMF21	–	plastic surface mounted package; 6 leads	SOT666

## 12 V PNP loadswitch

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**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
<b>Transistor TR1</b>					
$V_{CBO}$	collector-base voltage	open emitter	–	–15	V
$V_{CEO}$	collector-emitter voltage	open base	–	–12	V
$V_{EBO}$	emitter-base voltage	open collector	–	–6	V
$I_C$	collector current (DC)		–	–500	mA
$I_{CM}$	peak collector current		–	–1	A
$I_{BM}$	peak base current		–	–100	mA
$P_{tot}$	total power dissipation	$T_{amb} = 25\text{ °C}$ ; note 1	–	200	mW
<b>Transistor TR2</b>					
$V_{CBO}$	collector-base voltage	open emitter	–	50	V
$V_{CEO}$	collector-emitter voltage	open base	–	50	V
$V_{EBO}$	emitter-base voltage	open collector	–	10	V
$V_i$	input voltage				
	positive		–	+40	V
	negative		–	–10	V
$I_O$	output current (DC)		–	100	mA
$I_{CM}$	peak collector current		–	100	mA
$P_{tot}$	total power dissipation	$T_{amb} = 25\text{ °C}$ ; note 1	–	200	mW
<b>Per device</b>					
$P_{tot}$	total power dissipation	$T_{amb} = 25\text{ °C}$ ; note 1	–	300	mW
$T_{stg}$	storage temperature		–65	+150	°C
$T_j$	junction temperature		–	150	°C
$T_{amb}$	operating ambient temperature		–65	+150	°C

**Note**

1. Transistor mounted on an FR4 printed-circuit board.

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
<b>Per device</b>				
$R_{th(j-a)}$	thermal resistance from junction to ambient	notes 1 and 2	416	K/W

**Notes**

1. Transistor mounted on an FR4 printed-circuit board.
2. Reflow soldering is the only recommended soldering method.

## 12 V PNP loadswitch

## PEMF21

**CHARACTERISTICS**

$T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

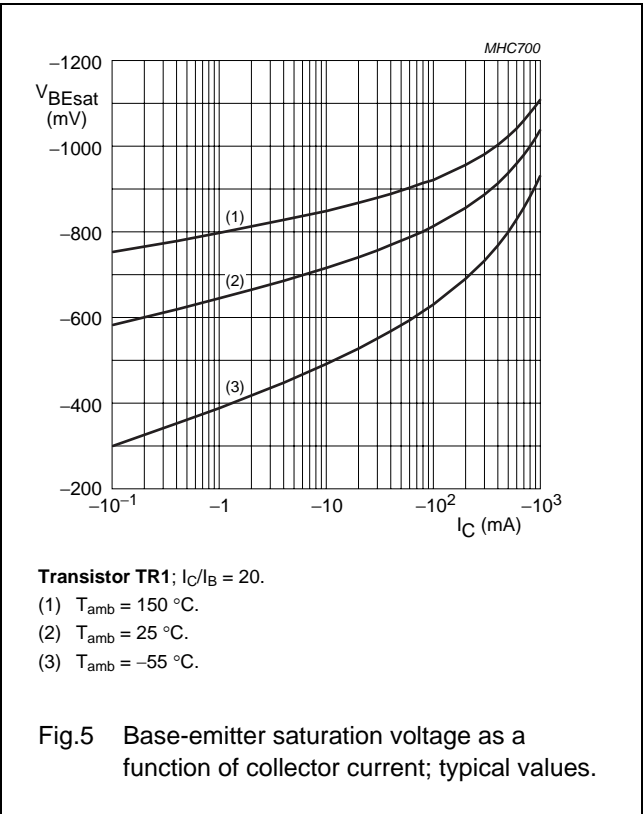
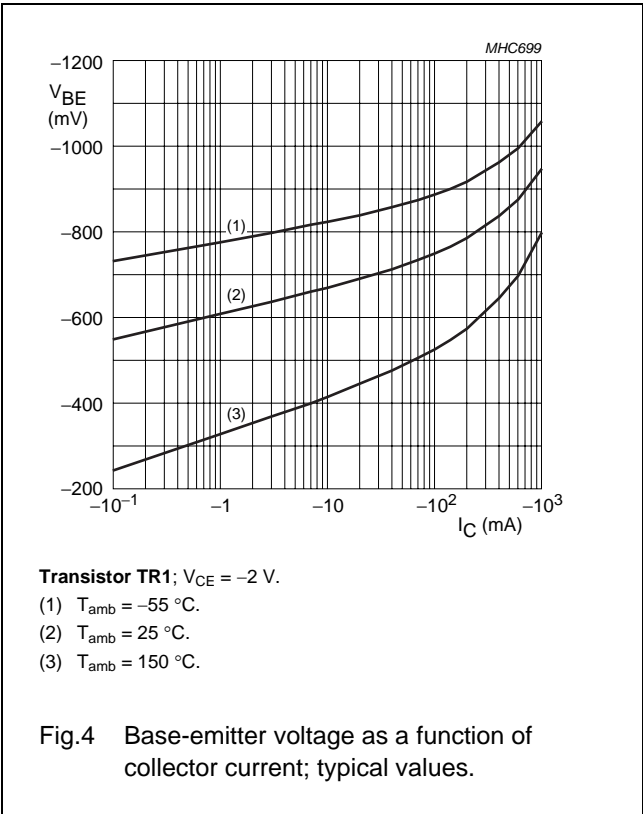
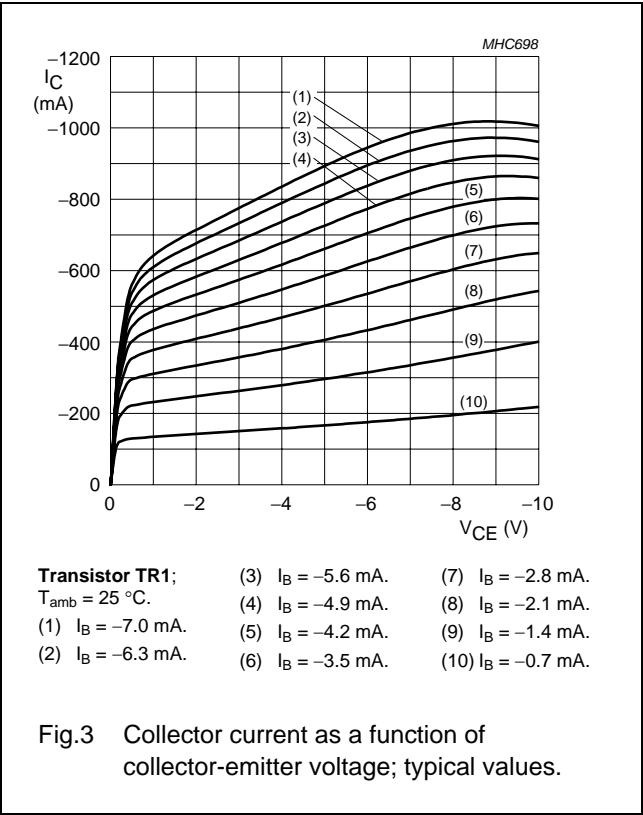
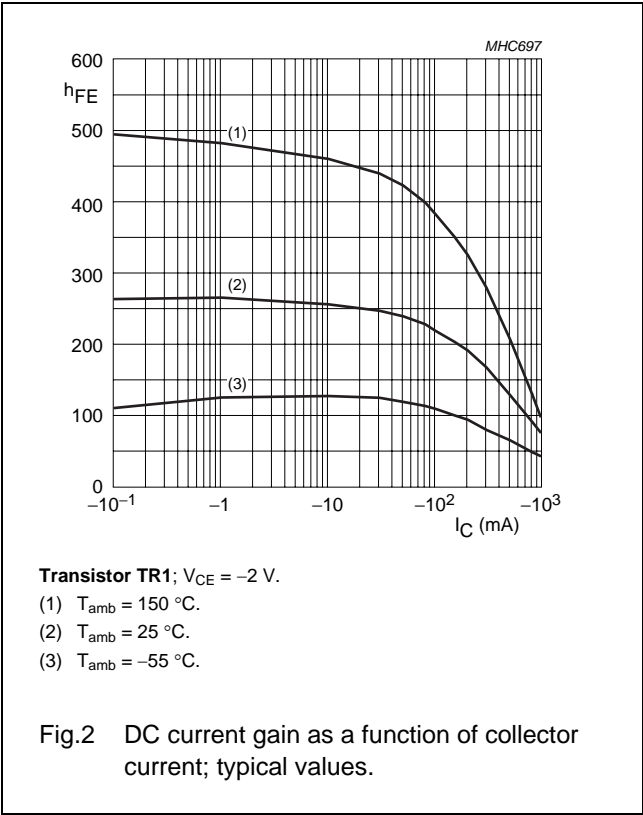
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Transistor TR1</b>						
$I_{\text{CBO}}$	collector-base cut-off current	$V_{\text{CB}} = -15\text{ V}; I_{\text{E}} = 0$	–	–	–100	nA
$I_{\text{EBO}}$	emitter-base cut-off current	$V_{\text{EB}} = -5\text{ V}; I_{\text{C}} = 0$	–	–	–100	nA
$h_{\text{FE}}$	DC current gain	$V_{\text{CE}} = -2\text{ V}; I_{\text{C}} = -10\text{ mA}$	200	–	–	
$V_{\text{CEsat}}$	collector-emitter saturation voltage	$I_{\text{C}} = -200\text{ mA}; I_{\text{B}} = -10\text{ mA}$	–	–	–250	mV
$R_{\text{CEsat}}$	equivalent on-resistance	$I_{\text{C}} = -500\text{ mA}; I_{\text{B}} = -50\text{ mA}; \text{note 1}$	–	300	500	m $\Omega$
$V_{\text{BEsat}}$	base-emitter saturation voltage	$I_{\text{C}} = -500\text{ mA}; I_{\text{B}} = -50\text{ mA}; \text{note 1}$	–	–	–1.1	V
$V_{\text{BEon}}$	base-emitter turn-on voltage	$V_{\text{CE}} = -2\text{ V}; I_{\text{C}} = -100\text{ mA}; \text{note 1}$	–	–	–0.9	V
$f_{\text{T}}$	transition frequency	$I_{\text{C}} = -100\text{ mA}; V_{\text{CE}} = -5\text{ V}; f = 100\text{ MHz}$	100	280	–	MHz
$C_{\text{c}}$	collector capacitance	$V_{\text{CB}} = -10\text{ V}; I_{\text{E}} = i_{\text{e}} = 0; f = 1\text{ MHz}$	–	–	10	pF
<b>Transistor TR2</b>						
$I_{\text{CBO}}$	collector-base cut-off current	$V_{\text{CB}} = 50\text{ V}; I_{\text{E}} = 0$	–	–	100	nA
$I_{\text{CEO}}$	collector-emitter cut-off current	$V_{\text{CE}} = 30\text{ V}; I_{\text{B}} = 0$	–	–	1	$\mu\text{A}$
$I_{\text{EBO}}$	emitter-base cut-off current	$V_{\text{EB}} = 5\text{ V}; I_{\text{C}} = 0$	–	–	400	$\mu\text{A}$
$h_{\text{FE}}$	DC current gain	$V_{\text{CE}} = 5\text{ V}; I_{\text{C}} = 5\text{ mA}$	30	–	–	
$V_{\text{CEsat}}$	collector-emitter saturation voltage	$I_{\text{C}} = 10\text{ mA}; I_{\text{B}} = 0.5\text{ mA}$	–	–	300	mV
$V_{\text{i(off)}}$	input-off voltage	$V_{\text{CE}} = 5\text{ V}; I_{\text{C}} = 100\text{ }\mu\text{A}$	–	–	0.5	V
$V_{\text{i(on)}}$	input-on voltage	$V_{\text{CE}} = 0.3\text{ V}; I_{\text{C}} = 10\text{ mA}$	3	–	–	V
$R_1$	input resistor		7	10	13	k $\Omega$
$\frac{R_2}{R_1}$	resistor ratio		0.8	1	1.2	
$C_{\text{c}}$	collector capacitance	$V_{\text{CB}} = 10\text{ V}; I_{\text{E}} = i_{\text{e}} = 0; f = 1\text{ MHz}$	–	–	2.5	pF

**Note**

1. Pulse test:  $t_{\text{p}} \leq 300\text{ }\mu\text{s}$ ;  $\delta \leq 0.02$ .

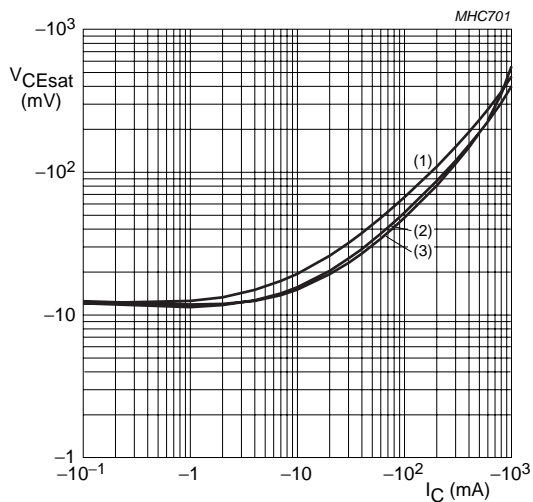
12 V PNP loadswitch

PEMF21



## 12 V PNP loadswitch

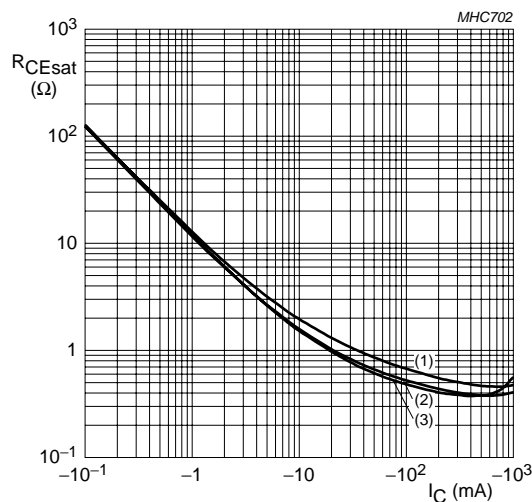
## PEMF21



Transistor TR1;  $I_C/I_B = 20$ .

- (1)  $T_{amb} = 150\text{ °C}$ .
- (2)  $T_{amb} = 25\text{ °C}$ .
- (3)  $T_{amb} = -55\text{ °C}$ .

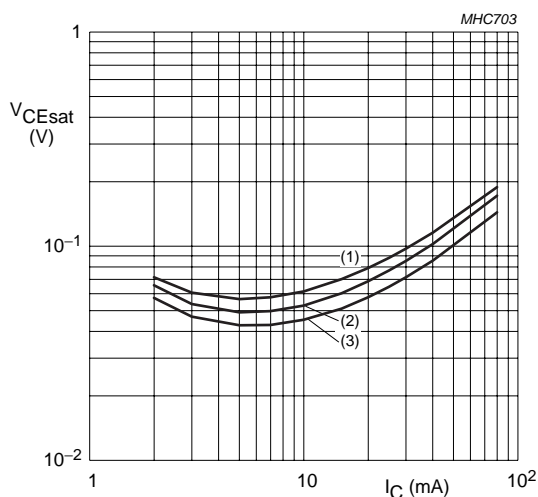
Fig.6 Collector-emitter saturation voltage as a function of collector current; typical values.



Transistor TR1;  $I_C/I_B = 20$ .

- (1)  $T_{amb} = -55\text{ °C}$ .
- (2)  $T_{amb} = 25\text{ °C}$ .
- (3)  $T_{amb} = 150\text{ °C}$ .

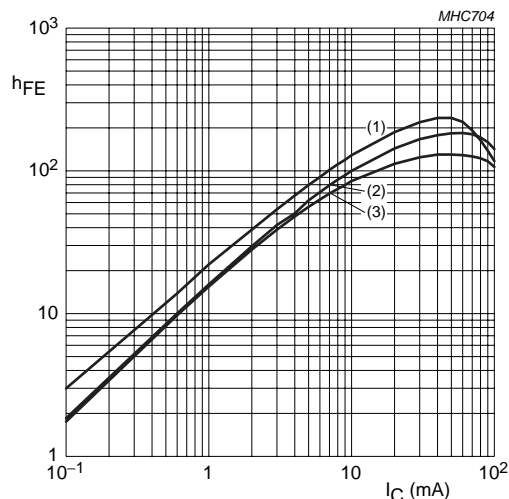
Fig.7 Equivalent on-resistance as a function of collector current; typical values.



Transistor TR2;  $I_C/I_B = 20$ .

- (1)  $T_{amb} = 100\text{ °C}$ .
- (2)  $T_{amb} = 25\text{ °C}$ .
- (3)  $T_{amb} = -40\text{ °C}$ .

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



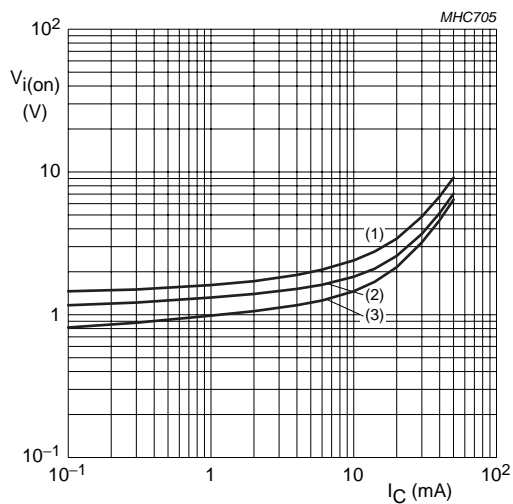
Transistor TR2;  $V_{CE} = 5\text{ V}$ .

- (1)  $T_{amb} = 150\text{ °C}$ .
- (2)  $T_{amb} = 25\text{ °C}$ .
- (3)  $T_{amb} = -40\text{ °C}$ .

Fig.9 DC current gain as a function of collector current; typical values.

## 12 V PNP loadswitch

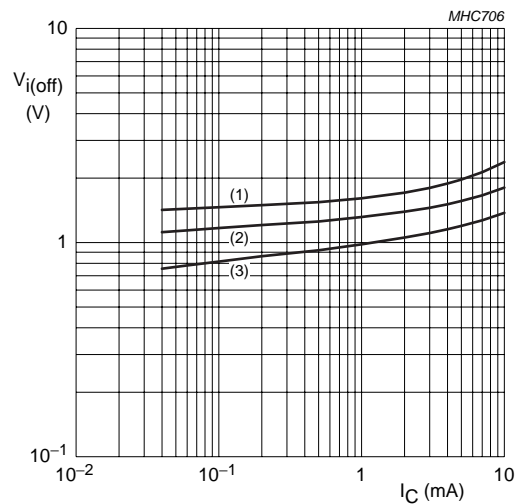
## PEMF21



Transistor TR2;  $V_{CE} = 0.3\text{ V}$ .

- (1)  $T_{amb} = -40^\circ\text{C}$ .
- (2)  $T_{amb} = 25^\circ\text{C}$ .
- (3)  $T_{amb} = 100^\circ\text{C}$ .

Fig.10 Input-on voltage as a function of collector current; typical values.



Transistor TR2;  $V_{CE} = 5\text{ V}$ .

- (1)  $T_{amb} = -40^\circ\text{C}$ .
- (2)  $T_{amb} = 25^\circ\text{C}$ .
- (3)  $T_{amb} = 100^\circ\text{C}$ .

Fig.11 Input-off voltage as a function of collector current; typical values.

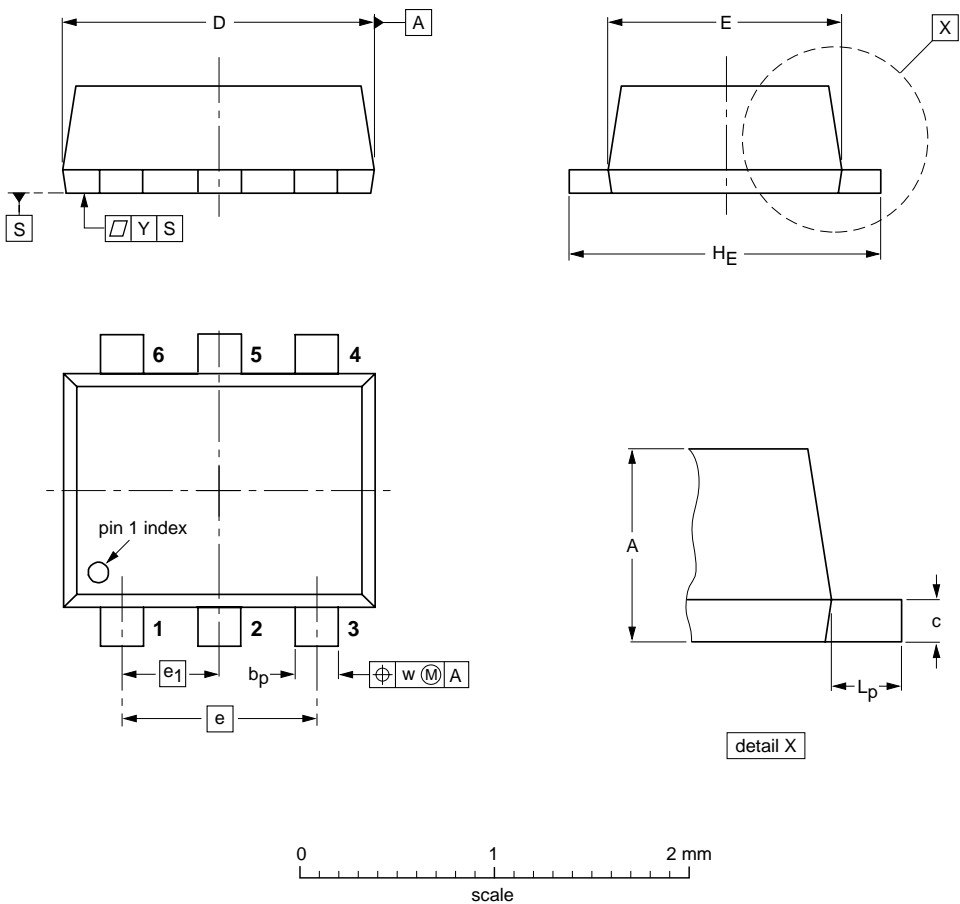
12 V PNP loadswitch

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PACKAGE OUTLINE

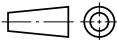
Plastic surface-mounted package; 6 leads

SOT666



DIMENSIONS (mm are the original dimensions)

UNIT	A	b <sub>p</sub>	c	D	E	e	e <sub>1</sub>	H <sub>E</sub>	L <sub>p</sub>	w	y
mm	0.6 0.5	0.27 0.17	0.18 0.08	1.7 1.5	1.3 1.1	1.0	0.5	1.7 1.5	0.3 0.1	0.1	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT666						04-11-08 06-03-16



## 12 V PNP loadswitch

## PEMF21

## DATA SHEET STATUS

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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## **Contact information**

For additional information please visit: <http://www.nxp.com>

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